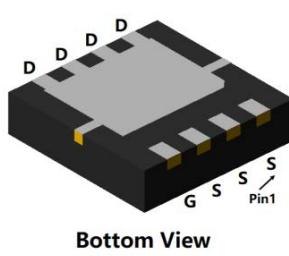
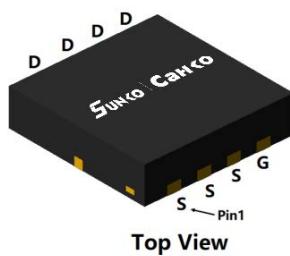
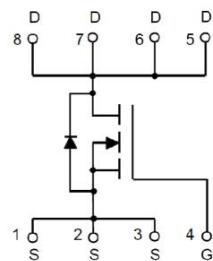


## P-Channel Enhancement Mode Field Effect Transistor



DFN333-8L



### Product Summary

- $V_{DS}$  -60V
- $I_D$  -22.5A
- $R_{DS(ON)}$  (at  $V_{GS}=-10V$ )  $<47\text{ m}\Omega$
- $R_{DS(ON)}$  (at  $V_{GS}=-4.5V$ )  $<60\text{ m}\Omega$
- 100% EAS Tested

### General Description

- Split gate trench MOSFET technology
- Low  $R_{DS(on)}$  & FOM
- Low  $C_{rss}$
- Extremely low switching loss
- Excellent stability and uniformity
- Moisture Sensitivity Level 3
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

### Applications

- Power management
- Industrial DC/DC Conversion Circuits

#### ■ Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		$V_{DS}$	-60	V
Gate-source Voltage		$V_{GS}$	$\pm 20$	V
Drain Current	$T_c=25^\circ\text{C}$	$I_D$	-22.5	A
	$T_c=100^\circ\text{C}$		-14.3	
Pulsed Drain Current <sup>A</sup>		$I_{DM}$	-90	A
Avalanche energy <sup>B</sup>		EAS	81	mJ
Total Power Dissipation <sup>C</sup>	$T_c=25^\circ\text{C}$	$P_D$	43	W
	$T_c=100^\circ\text{C}$		17.2	
Junction and Storage Temperature Range		$T_J, T_{STG}$	-55~+150	°C

#### ■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient <sup>D</sup>		$R_{\theta JA}$	20	25	°C/W
Thermal Resistance Junction-to-Ambient <sup>D</sup>	Steady-State		45	55	
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	2.4	2.9	

#### ■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SCQ23GP06A	F1	Q23GP06A	5000	10000	100000	13" reel

■ Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Conditions		Min	Typ	Max	Units
<b>Static Parameter</b>							
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$		-60			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=-60\text{V}, V_{\text{GS}}=0\text{V}$	$T_J=25^\circ\text{C}$			-1	$\mu\text{A}$
			$T_J=55^\circ\text{C}$			-5	
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}= \pm 20\text{V}, V_{\text{DS}}=0\text{V}$				$\pm 100$	nA
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}= V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$		-1.3	-1.8	-2.5	V
Static Drain-Source On-Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}= -10\text{V}, I_{\text{D}}=-20\text{A}$			35	47	$\text{m}\Omega$
		$V_{\text{GS}}= -4.5\text{V}, I_{\text{D}}=-10\text{A}$			45	60	
Gate Resistance	$R_g$	$f=1\text{MHz}, \text{Open Drain}$			12		$\Omega$
Diode Forward Voltage	$V_{\text{SD}}$	$I_{\text{S}}=-20\text{A}, V_{\text{GS}}=0\text{V}$			-0.95	-1.3	V
Maximum Body-Diode Continuous Current	$I_{\text{S}}$					-23	A
<b>Dynamic Parameters</b>							
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$			1100		$\text{pF}$
Output Capacitance	$C_{\text{oss}}$				350		
Reverse Transfer Capacitance	$C_{\text{rss}}$				28		
<b>Switching Parameters</b>							
Total Gate Charge	$Q_g(-10\text{V})$	$V_{\text{GS}}=-10\text{V}, V_{\text{DS}}=-30\text{V}, I_{\text{D}}=-20\text{A}$			18.7		$\text{nC}$
Total Gate Charge	$Q_g(-4.5\text{V})$				8.8		
Gate-Source Charge	$Q_{\text{gs}}$				4.7		
Gate-Drain Charge	$Q_{\text{gd}}$				3.0		
Reverse Recovery Charge	$Q_{\text{rr}}$	$I_F=-20\text{A}, dI/dt=100\text{A}/\mu\text{s}$			8.2		$\text{ns}$
Reverse Recovery Time	$t_{\text{rr}}$				20.2		
Turn-on Delay Time	$t_{\text{D(on)}}$				7.5		
Turn-on Rise Time	$t_r$	$V_{\text{GS}}=-10\text{V}, V_{\text{DD}}=-30\text{V}, R_L=2.5\Omega, R_{\text{GEN}}=6\Omega$			39.5		$\text{ns}$
Turn-off Delay Time	$t_{\text{D(off)}}$				43.6		
Turn-off fall Time	$t_f$				55.1		

- A. Repetitive rating; pulse width limited by max. junction temperature.  
B.  $V_{\text{DD}}=50\text{V}, R_G=25\Omega, L=0.5\text{mH}, I_{\text{AS}}=18\text{A}$ .  
C.  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.  
D. The value of  $R_{\text{BJA}}$  is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $TA = 25^\circ\text{C}$ . The Power dissipation PDSM is based on  $R_{\text{BJA}} \leq 10\text{s}$  and the maximum allowed junction temperature of  $150^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

## ■ Typical Performance Characteristics

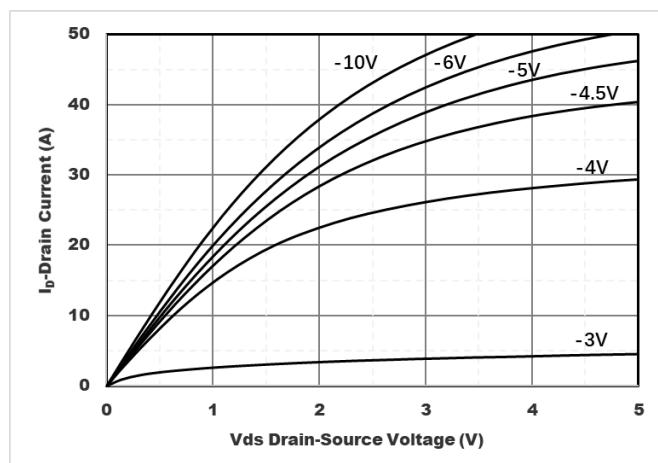


Figure1. Output Characteristics

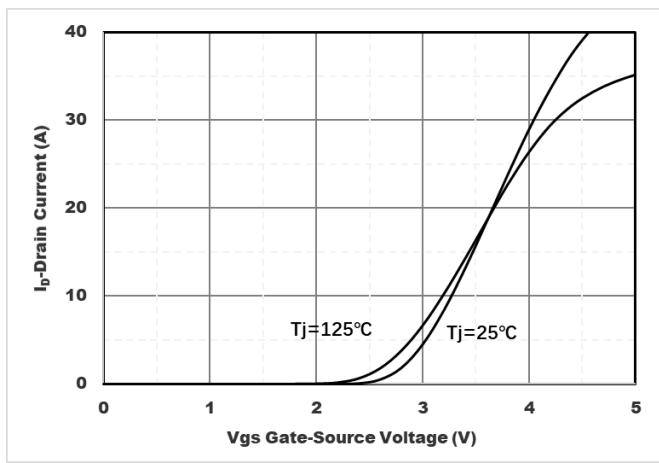


Figure2. Transfer Characteristics

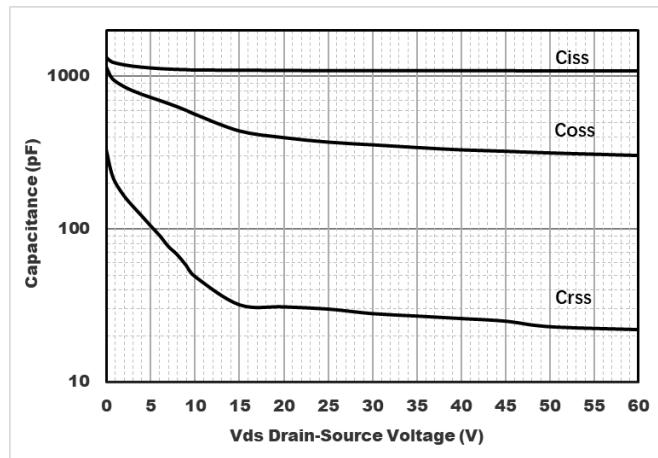


Figure3. Capacitance Characteristics

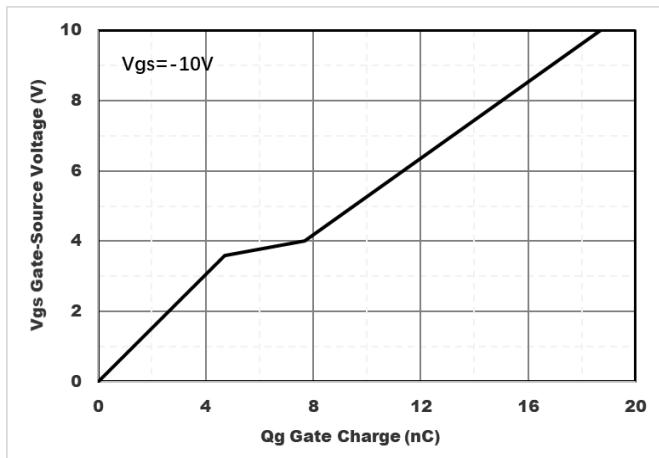


Figure4. Gate Charge

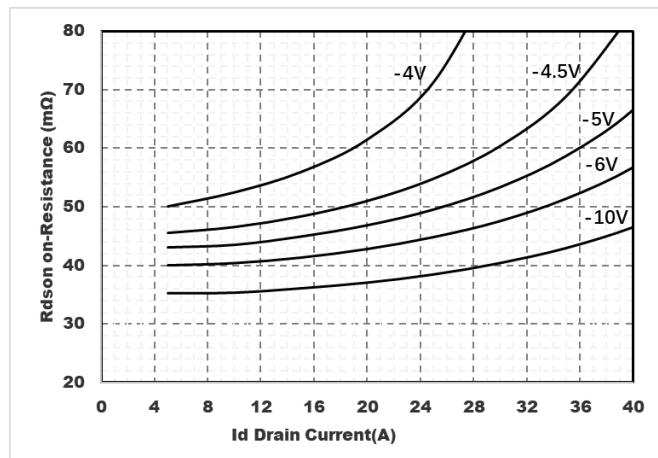


Figure5. : On-Resistance vs. Gate to Source Voltage

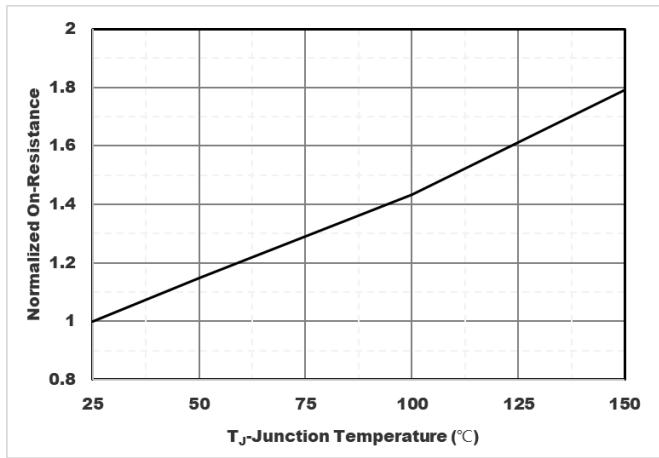


Figure6.Normalized On-Resistance

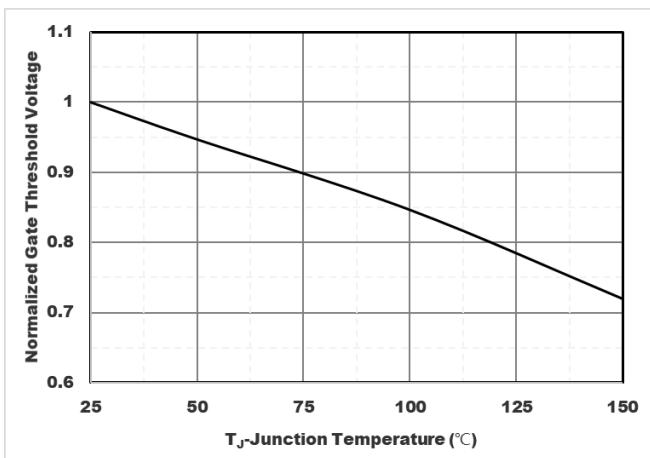


Figure 7. Normalized Gate Threshold Voltage

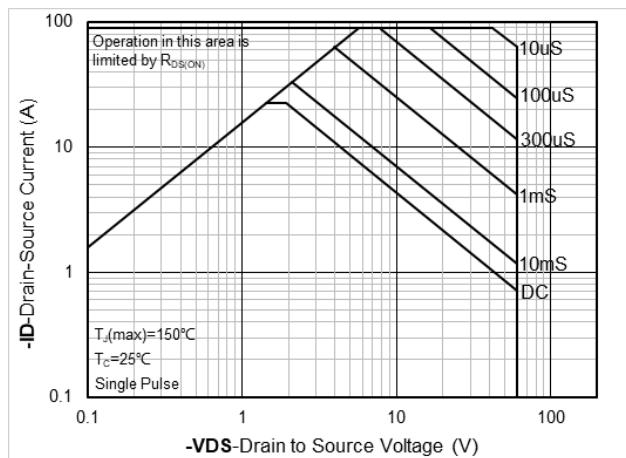


Figure 8. Safe Operation Area

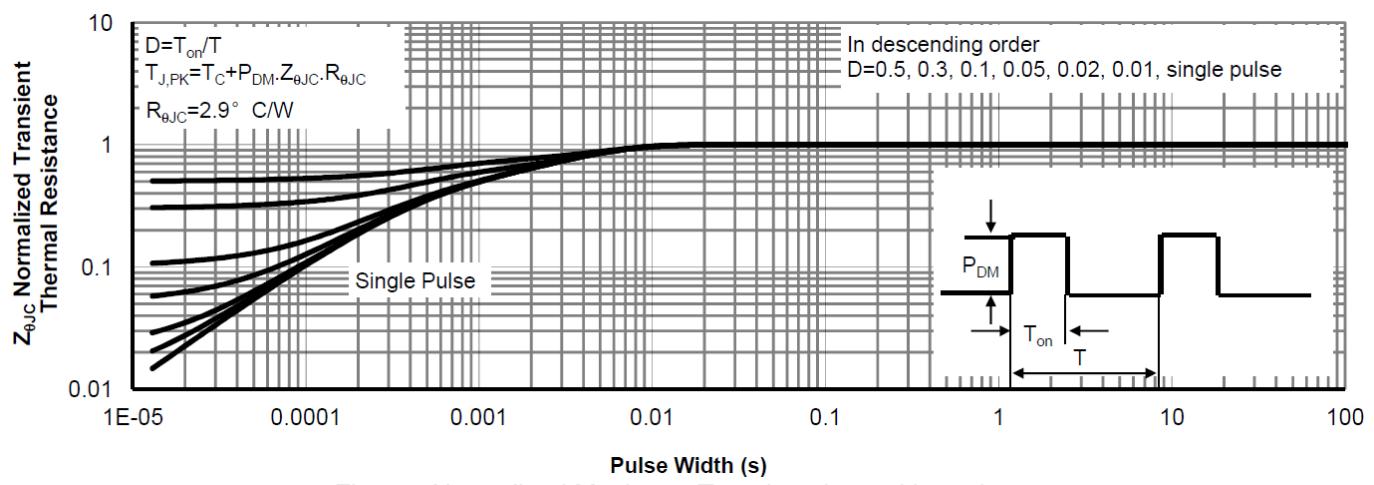
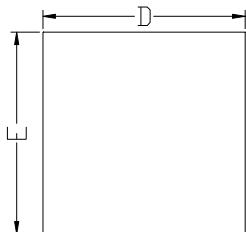
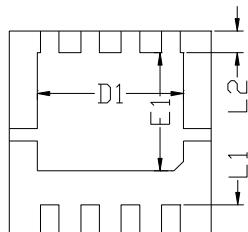


Figure 9. Normalized Maximum Transient thermal impedance

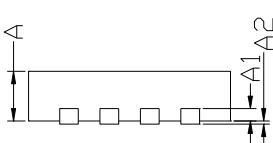
### ■ DFN3333-8L Package information



Top View  
正面视图



Bottom View  
背面视图

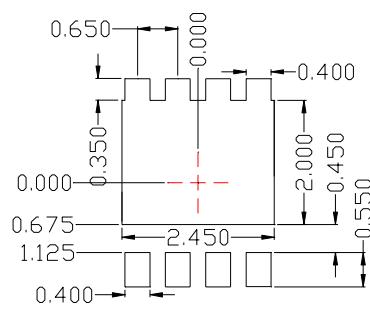


Side View  
侧面视图

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	3.15	3.25	3.35
E	3.15	3.25	3.35
A	0.70	0.80	0.90
A1	0.20	BSC	
A2			0.10
D1	2.20	2.35	2.50
E1	1.80	1.90	2.00
L1	0.35	0.45	0.55
L2	0.35	BSC	
b	0.20	0.30	0.40
e	0.65	BSC	

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: +/- 0.10mm.
3. The pad layout is for reference purposes only.



Suggested Solder Pad Layout  
Top View

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